11/22/2019 505788531

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HSUAN-WEI LEE	11/04/2019
CHENG-HSIU TSAI	11/05/2019
CHIU-TUNG WANG	11/05/2019
LI-DUAN TSAI	11/05/2019
TZU-YING CHEN	11/07/2019

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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16690642

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NAME OF SUBMITTER:	MICHAEL A CLEMENTI	
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DATE SIGNED:	11/22/2019	

Total Attachments: 2

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PATENT REEL: 051090 FRAME: 0558

ASSIGNMENT

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WHEREAS, <u>Hsuan-Wei LEE</u>, <u>Cheng-Hsiu TSAI</u>, <u>Chiu-Tung WANG</u>, <u>Li-Duan TSAI</u> and <u>Tzu-Ying CHEN</u> hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: POLYMER, ION-EYCHANGE MEMBRANE, AND STRUCTURE ENHANCED MEMORANE

EMPLOYING THE SAME	AND STRUCTURE-ENHANCED MEMBRANE
Filed: 11/21/2019	Serial No. 16/690,642
Executed on: November 4, 2019; November 5,	2019; November 5, 2019 and November 7, 2019
Sec. 4, Chung Hsing Rd., Chutung, Hsinchu 316 hereinafter referred to as ASSIGNEE, is des	nology Research Institute of No. 195 040, Taiwan, R. O. C. sirous of acquiring ASSIGNOR'S interest in the I.S. Letters Patent which may be granted on the
good and valuable consideration, receipt of Assignor has/have sold, assigned and transfer and transfer unto the said Assignee, and Assignes, title and interest in and to the simprovements thereon, and in and to any Let the same in the United States, the said interfully and exclusively as it would have bee Assignment and transfer not been made, to the may be granted thereon, or of any division substitution, conversion, reissue, prolongation Assignor further agrees/agree that Assignee, but at Assignee's expense, cooper application and/or applications, execute, verpapers, including applications for Letters Patent of assignment and transfer thereof, and will prequest, to obtain or maintain Letters Patent title thereto in said Assignee, or Assignee's su	at he/she/they will, without charge to said erate with Assignee in the prosecution of said erify, acknowledge and deliver all such further tent and for the reissue thereof, and instruments erform such other acts as Assignee lawfully may for said invention and improvement, and to vest
Full name of sole or first inventor: Hsuan-W	Y .
Inventor's signature: HSUAN - Wei LEB	Date: >019/11/4
Full name of second inventor: Cheng-Hsiu	TSAI
Inventor's signature: Weng HSTN TSAZ	Date: >019/11/05
Full name of third inventor: Chiu-Tung WA	ANG
Inventor's signature: Chiu-lung WAVG	Date: 1019/11/05
	<u> </u>

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TSAI
Date:
CHEN
Date: 11.07.2019

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